

Vishay Siliconix

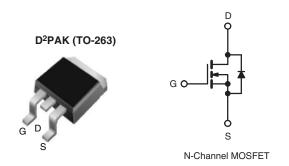
RoHS'

COMPLIANT

HALOGEN **FREE** 

### Power MOSFET

| PRODUCT SUMMARY            |                          |       |  |  |
|----------------------------|--------------------------|-------|--|--|
| V <sub>DS</sub> (V)        | 60                       |       |  |  |
| R <sub>DS(on)</sub> (Ω)    | $V_{GS} = 5.0 \text{ V}$ | 0.028 |  |  |
| Q <sub>g</sub> (Max.) (nC) | 66                       |       |  |  |
| Q <sub>gs</sub> (nC)       | 12                       |       |  |  |
| Q <sub>gd</sub> (nC)       | 43                       |       |  |  |
| Configuration              | Single                   |       |  |  |



#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 **Definition**
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Logic-Level Gate Drive
- R<sub>DS(on)</sub> Specified at V<sub>GS</sub> = 4 V and 5 V
  175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D<sup>2</sup>PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

| ORDERING INFORMATION            |                             |                             |  |  |  |
|---------------------------------|-----------------------------|-----------------------------|--|--|--|
| Package                         | D <sup>2</sup> PAK (TO-263) | D <sup>2</sup> PAK (TO-263) |  |  |  |
| Lead (Pb)-free and Halogen-free | SiHLZ44S-GE3                | SiHLZ44STRR-GE3a            |  |  |  |
| Lead (Pb)-free                  | IRLZ44SPbF                  | IRLZ44STRRPbFa              |  |  |  |
|                                 | SiHLZ44S-E3                 | SiHLZ44STR-E3 <sup>a</sup>  |  |  |  |

#### Note

a. See device orientation.

| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted) |                          |   |   |                  |       |  |
|--|--------------------------|---|---|------------------|-------|--|
| PARAMETER  |                          |   | SYMBOL  | LIMIT            | UNIT  |  |
| Drain-Source Voltage   |                          |   | $V_{DS}$  | 60               | V     |  |
| Gate-Source Voltage  |                          |   | $V_{GS}$  | ± 10             | 7 v   |  |
| Continuous Drain Current <sup>f</sup>  | V <sub>GS</sub> at 5.0 V | $T_{\rm C} = 25  ^{\circ}{\rm C}$<br>$T_{\rm C} = 100  ^{\circ}{\rm C}$ | - I <sub>D</sub>                                | 50               |       |  |
| Continuous Drain Current   | V <sub>GS</sub> at 5.0 v | T <sub>C</sub> = 100 °C   |   | 36               | Α     |  |
| Pulsed Drain Current <sup>a</sup>  | urrent <sup>a</sup>      |   |   | 200              | ı     |  |
| Linear Derating Factor   |                          |   |   | 1.0              | W/°C  |  |
| Linear Derating Factor (PCB Mount)e  |                          |   |   | 0.025            | VV/ C |  |
| Single Pulse Avalanche Energy <sup>b</sup>                                       |                          |   | E <sub>AS</sub>                                 | 400              | mJ    |  |
| Maximum Power Dissipation  | T <sub>C</sub> =         | T <sub>C</sub> = 25 °C  |   | 150              | W     |  |
| Maximum Power Dissipation (PCB Mount)e   | T <sub>A</sub> = 25 °C   |   | $P_{D}$   | 3.7              |       |  |
| Peak Diode Recovery dV/dt <sup>c</sup>   |                          |   | dV/dt   | 4.5              | V/ns  |  |
| Operating Junction and Storage Temperature Range                                 |                          |   | T <sub>J</sub> , T <sub>stg</sub> - 55 to + 175 |                  | °C    |  |
| Soldering Recommendations (Peak Temperature) <sup>d</sup>                        | for 10 s                 |   |   | 300 <sup>d</sup> | ]     |  |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 25 V, starting  $T_J$  = 25 °C, L = 179  $\mu$ H,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 51 A (see fig. 12). c.  $I_{SD}$  < 51 A, dI/dt < 250 A/ $\mu$ s,  $V_{DD}$  <  $V_{DS}$ ,  $T_J$  < 175 °C.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).
- f. Current limited by the package, (die current = 51 A).

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRLZ44S, SiHLZ44S

# Vishay Siliconix



| THERMAL RESISTANCE RATINGS                           |                   |      |      |      |  |
|--|-------------------|------|------|------|--|
| PARAMETER  | SYMBOL            | TYP. | MAX. | UNIT |  |
| Maximum Junction-to-Ambient                          | R <sub>thJA</sub> | -    | 62   |      |  |
| Maximum Junction-to-Ambient (PCB Mount) <sup>a</sup> | R <sub>thJA</sub> | -    | 40   | °C/W |  |
| Maximum Junction-to-Case (Drain)                     | R <sub>thJC</sub> | -    | 1.0  |      |  |

#### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

| PARAMETER                                     | SYMBOL                | TES  | MIN.  | TYP.       | MAX.      | UNIT                 |                  |
|---|-----------------------|--|---|------------|-----------|----------------------|------------------|
| Static  |                       | <u>'</u>   |   | Į          |           |                      | l .              |
| Drain-Source Breakdown Voltage                | V <sub>DS</sub>       | V <sub>GS</sub>  | 60  | -          | -         | V                    |                  |
| V <sub>DS</sub> Temperature Coefficient       | $\Delta V_{DS}/T_{J}$ | Reference  | e to 25 °C, I <sub>D</sub> = 1 mA   | -          | 0.070     | -                    | V/°C             |
| Gate-Source Threshold Voltage                 | V <sub>GS(th)</sub>   | V <sub>DS</sub> =  | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$  |            | -         | 2.0                  | V                |
| Gate-Source Leakage                           | I <sub>GSS</sub>      | V <sub>GS</sub> = ± 10 V   |   | -          | -         | ± 100                | nA               |
| 7. 0 . 1                                      | I <sub>DSS</sub>      | V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V  |   | -          | -         | 25                   |                  |
| Zero Gate Voltage Drain Current               |                       | V <sub>DS</sub> = 48 V   | V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C  | -          | -         | 250                  | μA               |
| Duain Cauras On State Besistance              | П                     | V <sub>GS</sub> = 5.0 V  | I <sub>D</sub> = 31 A <sup>b</sup>  | -          | -         | 0.028                | Ω                |
| Drain-Source On-State Resistance              | R <sub>DS(on)</sub>   | V <sub>GS</sub> = 4.0 V  | I <sub>D</sub> = 25 A <sup>b</sup>  | -          | -         | 0.039                |                  |
| Forward Transconductance                      | 9 <sub>fs</sub>       | V <sub>DS</sub> :  | V <sub>DS</sub> = 25 V, I <sub>D</sub> = 31 A <sup>b</sup>                                  |            | -         | -                    | S                |
| Dynamic                                       |                       |  |   |            |           |                      |                  |
| Input Capacitance                             | C <sub>iss</sub>      | $V_{GS} = 0 \text{ V},$<br>$V_{DS} = 25 \text{ V},$<br>f = 1.0  MHz,  see fig. 5                           |   | -          | 3300      | -                    | pF               |
| Output Capacitance                            | C <sub>oss</sub>      |  |   | -          | 1200      | -                    |                  |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>      |  |   | -          | 200       | -                    |                  |
| Total Gate Charge                             | $Q_g$                 |  |   | -          | -         | 66                   |                  |
| Gate-Source Charge                            | $Q_{gs}$              | $V_{GS} = 5.0 \text{ V}$   | $V_{GS} = 5.0 \text{ V}$ $I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$<br>see fig. 6 and 13b |            | -         | 12                   | nC               |
| Gate-Drain Charge                             | $Q_{gd}$              |  |   | -          | -         | 43                   | 1                |
| Turn-On Delay Time                            | t <sub>d(on)</sub>    |  |   | -          | 17        | -                    |                  |
| Rise Time                                     | t <sub>r</sub>        | $V_{DD} = 30 \text{ V}, I_D = 51 \text{ A},$ $R_g = 4.6 \Omega, R_D = 0.56 \Omega, \text{ see fig. } 10^b$ |   | -          | 230       | -                    | ns               |
| Turn-Off Delay Time                           | $t_{d(off)}$          |  |   | -          | 42        | -                    |                  |
| Fall Time                                     | t <sub>f</sub>        |  |   | -          | 110       | -                    |                  |
| Internal Drain Inductance                     | $L_D$                 | Between lead,<br>6 mm (0.25") from<br>package and center of<br>die contact                                 |   | -          | 4.5       | -                    | nЦ               |
| Internal Source Inductance                    | L <sub>S</sub>        |  |   | -          | 7.5       | -                    | - nH             |
| <b>Drain-Source Body Diode Characteristic</b> | s                     |  |   |            |           |                      |                  |
| Continuous Source-Drain Diode Current         | I <sub>S</sub>        | MOSFET symbol showing the integral reverse p - n junction diode  |   | -          | -         | 50°                  | Α                |
| Pulsed Diode Forward Current <sup>a</sup>     | I <sub>SM</sub>       |  |   | -          | -         | 200                  |                  |
| Body Diode Voltage                            | $V_{SD}$              | $T_J = 25  ^{\circ}\text{C},  I_S = 51  \text{A},  V_{GS} = 0  \text{V}^{\text{b}}$                        |   | -          | -         | 2.5                  | V                |
| Body Diode Reverse Recovery Time              | t <sub>rr</sub>       | T _ 25 °C 1  | - E1 A dI/dt - 100 A/:-ah   | -          | 130       | 180                  | ns               |
| Body Diode Reverse Recovery Charge            | Q <sub>rr</sub>       | $T_J = 25 ^{\circ}\text{C}, I_F = 51 \text{A}, dI/dt = 100 \text{A/}\mu\text{s}^b$                         |   | -          | 0.84      | 1.3                  | μC               |
| Forward Turn-On Time                          | t <sub>on</sub>       | Intrinsic turn-on time is negligible (turn-  |   | -on is dor | ninated b | y L <sub>S</sub> and | L <sub>D</sub> ) |

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width  $\leq 300~\mu s$ ; duty cycle  $\leq 2~\%$ . c. Current limited by the package, (Die Current = 51 A).



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

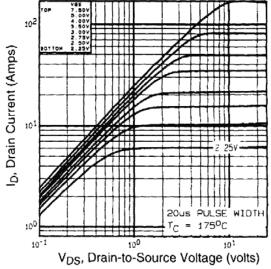


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150 °C

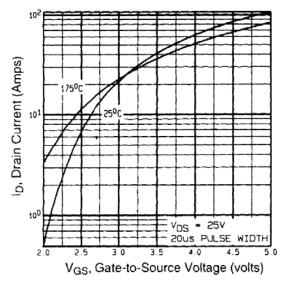


Fig. 3 - Typical Transfer Characteristics

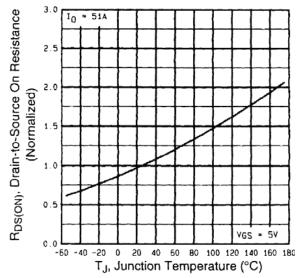


Fig. 4 - Normalized On-Resistance vs. Temperature

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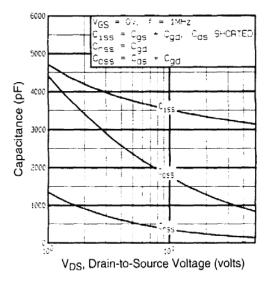


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

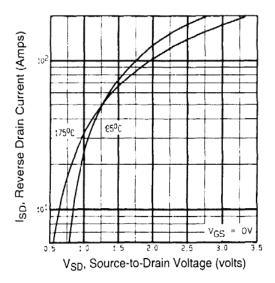


Fig. 7 - Typical Source-Drain Diode Forward Voltage

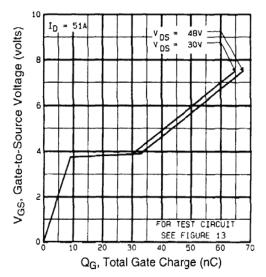


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

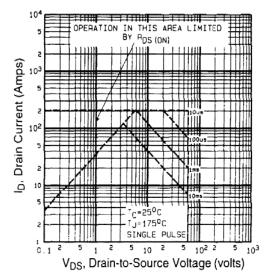


Fig. 8 - Maximum Safe Operating Area





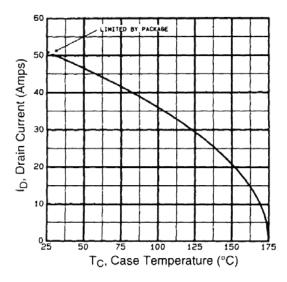


Fig. 9 - Maximum Drain Current vs. Case Temperature

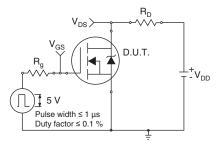


Fig. 10a - Switching Time Test Circuit

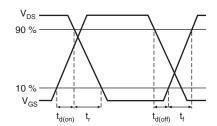


Fig. 10b - Switching Time Waveforms

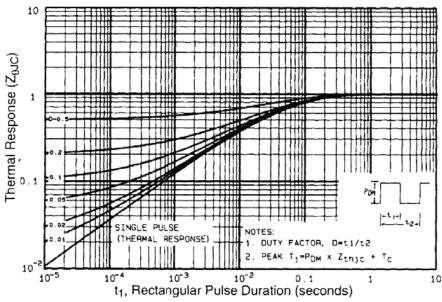
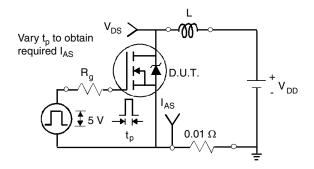


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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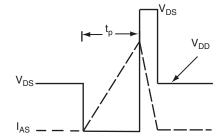


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

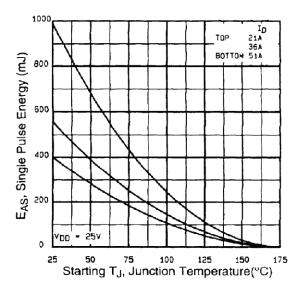


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

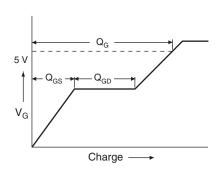


Fig. 13a - Basic Gate Charge Waveform

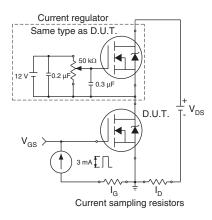
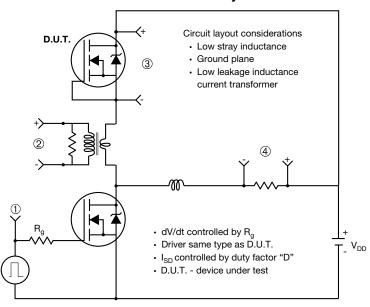


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



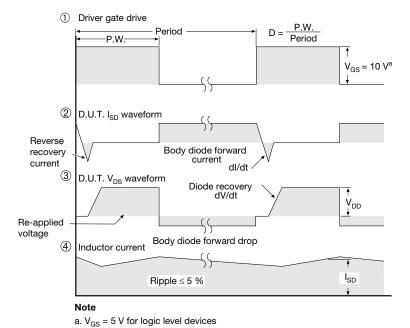


Fig. 14 - For N-Channel

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### RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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Revision: 13-Jun-16 1 Document Number: 91000

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